This article was downloaded by:

On: 21 January 2011

Access details: Access Details: Free Access

Publisher Taylor & Francis

Informa Ltd Registered in England and Wales Registered Number: 1072954 Registered office: Mortimer House, 37-

41 Mortimer Street, London W1T 3JH, UK



The Journal of Adhesion

Publication details, including instructions for authors and subscription information: http://www.informaworld.com/smpp/title~content=t713453635

Calendar of Events

To cite this Article (2009) 'Calendar of Events', The Journal of Adhesion, 85: 6, 377 - 379

To link to this Article: DOI: 10.1080/00218460903028235 URL: http://dx.doi.org/10.1080/00218460903028235

PLEASE SCROLL DOWN FOR ARTICLE

Full terms and conditions of use: http://www.informaworld.com/terms-and-conditions-of-access.pdf

This article may be used for research, teaching and private study purposes. Any substantial or systematic reproduction, re-distribution, re-selling, loan or sub-licensing, systematic supply or distribution in any form to anyone is expressly forbidden.

The publisher does not give any warranty express or implied or make any representation that the contents will be complete or accurate or up to date. The accuracy of any instructions, formulae and drug doses should be independently verified with primary sources. The publisher shall not be liable for any loss, actions, claims, proceedings, demand or costs or damages whatsoever or howsoever caused arising directly or indirectly in connection with or arising out of the use of this material.

The Journal of Adhesion, 85:377–379, 2009 Copyright © Taylor & Francis Group, LLC ISSN: 0021-8464 print/1545-5823 online DOI: 10.1080/00218460903028235

Taylor & Francis
Taylor & Francis Group

I CALENDAR OF EVENTS

Announcement and Call for Papers 3rd International Conference ACE-X 2009: Special session 'Adhesive Bonding'.

The 3rd International Conference ACE-X 2009 will take place in Rome, Italy, 22–23 June 2009. The conference will be held in the Grand Hotel Palazzo Carpegna located a few minutes from the Vatican City and Rome city centre. The conference is co-chaired by Andreas Öchsner (Malaysia), Lucas F. M. da Silva (Portugal) and H Altenbach (Germany), and will deal with topics related to Advanced Computational Engineering and Experimenting. As in the previous ACE-X conferences, there will be a special session about 'Adhesive Bonding.' The 'Adhesive Bonding' special session is co-organized by Lucas F. M. da Silva (Portugal) and Luca Goglio (Italy). The scientific committee of the 'Adhesive Bonding' special session includes R. D. Adams (UK), Chiaki Sato (Japan), Erol Sancaktar (USA), Gary Critchlow (UK), Hyun-Joong Kim (South Korea), Ian Ashcroft (UK), Jean-Yves Cognard (France), JC Suarez (Spain), Liyong Tong (Australia), Marcelo de Moura (Portugal), Toshiyuki Sawa (Japan) and W Possart (Germany).

The following aspects of adhesive bonding will be covered, among others:

Fundamental aspects of adhesion; the science and technology of surfaces; advances in adhesive materials; mechanical properties of bonded joints; innovative designs and applications; testing and standardization; industrial aspects; quality procedures; environmental and ecological aspects; bio-adhesion.

Authors who wish to make a presentation (oral or poster) are requested to submit a short abstract (one single A4 page possibly with a diagram and references) in English, by 27 March 2009, in the web site of the conference http://ace-x2009.com/abstract.html.

Important Dates:

- 27 March 2009 Abstract submission deadline
- 03 April 2009 Notification of acceptance to authors
- 17 April 2009 Early bird registration
- 20 April 2009 Accommodation reservation

The accepted abstracts submitted to ACE-X 2009 will be published in the Book of Abstracts which will be available to delegates at registration upon the start of the conference.

Selected papers of the 'Adhesive Bonding' special session will be published in the Journal of Adhesion Science and Technology, The Journal of Adhesion and International Journal of Adhesion and Adhesives. Full length papers should be submitted at the conference site (two hard copies and pdf file).

The organisers will select the most appropriate journal and deal with the review process.

More information is available through:

The web page of the Conference: www.ace-x2009.com

Lucas F. M. da Silva: Faculdade de Engenharia, Universidade do Porto, Rua Dr. Roberto Frias, 4200-465 Porto, Portugal, Tel: +351 22 5081706, Fax: +351 22 5081445, E-mail: lucas@fe.up.pt

Luca Goglio: Dipartimento di Meccanica, Politecnico di Torino, Corso Duca degli Abruzzi 24, 10129 Torino, Italy, Tel: +390115646934, Fax: +390115646999, E-mail: luca.goglio@polito.it

Announcement and Call for Papers

September 28–30, 2009, Harveys Resort Hotel & Casino, South Lake Tahoe, Nevada, USA.

The ninth in a series of conferences sponsored every 4–5 years by the USDA Forest Service, Forest Products Laboratory and Forest Products Society, designed to provide a comprehensive update of the science and technology of wood adhesives and bonded wood products. The conferences will be held in conjunction with ASTM International D 14.30 Wood Adhesives Subcommittee on October 1, 2009.

Information transfer during the 3-day conference will take place via plenary, technical and poster presentations and tabletop exhibits on the following subject areas:

- Formaldehyde and environmental issues
- Biobased adhesives
- Resin chemistry
- Analytical methods
- Composites
- Engineered wood structures
- Modeling
- Other topics

This conference is sponsored by the USDA Forest Service, Forest Products Laboratory and Forest Products Society. To submit a formal or poster abstract electronically or for the most recent information on the program, please visit FPS online at:

www.forestprod.org/confadhesives09.html

Paper Abstracts are due December 15, 2008.

For more information, contact the Forest Products Society, 2801 Marshall Court, Madison, WI 53705-2295, USA:

Phone: 608-231-1361; Fax: 608-231-2152; E-mail: conferences@

forestprod.org.

Web site: www.forestprod.org